# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





### **Features and Benefits**

- Exceptional reliability
- Small fully-molded SIP package with heatsink mounting for high thermal dissipation and long life
- $V_{\text{DRM}}$  of 600 V
- 3 A<sub>RMS</sub> on-state current
- Uniform switching
- UL Recognized Component



### Package: 3-pin SIP (TO-220F)



Not to scale

### Description

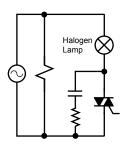
This Sanken triac (bidirectional triode thyristor) is designed for AC power control, providing reliable, uniform switching for full-cycle AC applications.

In comparison with other products on the market, the TMA36H-L provides increased isolation voltage (1800 VAC<sub>RMS</sub>), guaranteed for up to 1 minute, and greater peak nonrepetitive off-state voltage,  $V_{DSM}$  (700 V). In addition, commutation dv/dt and (dv/dt)c are improved.

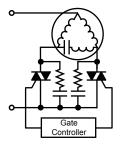
### Applications

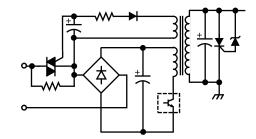
- Residential and commercial appliances: vacuum cleaners, rice cookers, TVs, home entertainment
- White goods: washing machines
- Office automation power control, photocopiers
- Motor control for small tools
- Temperature control, light dimmers, electric blankets
- General use switching mode power supplies (SMPS)

### **Typical Applications**



Heater control (for example, LBP. PPC, MFP)





Two-phase motor control (for example, washing machine)

In-rush current control (for example, SMPS)

#### **Selection Guide**

Part Number	Package	Packing	
TMA36H-L	3-pin fully molded SIP with heatsink mount	50 pieces per tube	

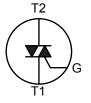
#### **Absolute Maximum Ratings**

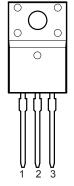
Characteristic	Symbol		Notes	Rating	Units
Peak Repetitive Off-State Voltage	V <sub>DRM</sub>	R <sub>GREF</sub> = ∞		600	V
Peak Non-Repetitive Off-State Voltage	V <sub>DSM</sub>	R <sub>GREF</sub> = ∞		700	V
Isolation Voltage	V <sub>ISO</sub>	AC RMS app	lied for 1 minute between lead and case	1800	V
RMS On-State Current	I <sub>T(RMS)</sub>	50/60 Hz full cycle sine wave, total Conduction angle ( $\alpha$ +) + ( $\alpha$ -) = 360°, T <sub>c</sub> = 109°C		3	A
Surge On-State Current	I <sub>TSM</sub>	f = 60 Hz	Full cycle sine wave, peak value, non-repetitive, initial $T_J$ = 25°C	32	А
		f = 50 Hz		30	A
I <sup>2</sup> t Value for Fusing	l²t	Value for 50 Hz half cycle sine wave, 1 cycle, I <sub>TSM</sub> = 30 A		4.5	A <sup>2</sup> •s
Critical Rising Rate of On-State Current	di/dt	$ \begin{array}{l} I_{T} = I_{T(RMS)} \times \sqrt{2}, V_{D} = V_{DRM} \times 0.5,  f \leq 60 \; Hz,  t_{gw} \geq 10 \; \mu s, \\ t_{gr} \leq 250 \; ns,  I_{gp} \geq 60 \; mA \; (refer \; to \; Gate \; Trigger \; Current \; diagram) \end{array} $		25	A/µs
Peak Gate Current	I <sub>GM</sub>	f ≥ 50 Hz, duty cycle ≤ 10%		0.5	A
Peak Gate Power Dissipation	P <sub>GM</sub>	f ≥ 50 Hz, duty cycle ≤ 10%		3	W
Average Gate Power Dissipation	P <sub>GM(AV)</sub>			0.3	W
Junction Temperature	TJ			-40 to 125	°C
Storage Temperature	T <sub>stg</sub>			-40 to 125	°C

#### Thermal Characteristics May require derating at maximum conditions

Characteristic	Symbol	Test Conditions	Value	Units
Package Thermal Resistance (Junction to Case)	$R_{\theta JC}$	For AC	4.6	°C/W

### **Pin-out Diagram**





### Terminal List Table

Number	Name	Function	
1	T1	Main terminal, gate referenced	
2	T2	Main terminal connect to signal side	
3	G	Gate control	

All performance characteristics given are typical values for circuit or system baseline design only and are at the nominal operating voltage and an ambient temperature,  $T_A$ , of 25°C, unless otherwise stated.



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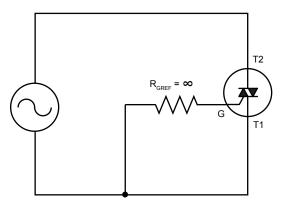


### **ELECTRICAL CHARACTERISTICS**

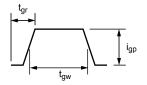
Characteristics	Symbol	т.	Min.	Тур.	Max.	Unit	
Off-State Leakage Current		$V_D = V_{DRM}$ , $T_J = 125^{\circ}C$ , $R_{GREF} = \infty$ using test circuit 1		_	_	2.0	mA
	I <sub>DRM</sub>	$V_D = V_{DRM}, T_J = 25^{\circ}C, I$	_	_	100	μA	
On-State Voltage	V <sub>TM</sub>	$I_{T} = 4.5 \text{ A}, T_{J} = 25^{\circ}\text{C}$		_	_	1.5	V
Gate Trigger Voltage		Quadrant I: T2+, G+	V <sub>D</sub> = 12 V, R <sub>L</sub> = 20 Ω, T <sub>J</sub> = 25°C	_	_	1.5	V
	V <sub>GT</sub>	Quadrant II: T2+, G-		_	_	1.5	V
		Quadrant III: T2-, G-		_	-	1.5	V
Gate Trigger Current	I <sub>GT</sub>	Quadrant I: T2+, G+	V <sub>D</sub> = 12 V, R <sub>L</sub> = 20 Ω, T <sub>J</sub> = 25°C	_	_	20	mA
		Quadrant II: T2+, G-		_	_	20	mA
		Quadrant III: T2-, G-		_	-	20	mA
Gate Non-trigger Voltage	V <sub>GD</sub>	$V_{\rm D} = V_{\rm DRM} \times 0.5, R_{\rm L} = 4 \text{ k}\Omega, T_{\rm J} = 125^{\circ}\text{C}$		0.2	-	_	V
Critical Rising Rate of Off-State Voltage during Commutation*	(dv/dt)c	V <sub>D</sub> = 400 V, (di/dt)c = -	5	_	_	V/µs	
Critical Rising Rate of Off-StateVoltage	dv/dt	$V_D = V_{DRM} \times 0.66, R_{GRE}$	100	_	_	V/µs	

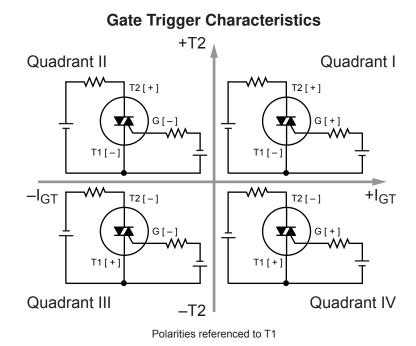
\*Where  $I_{TP}$  is the peak current through T2 to T1.

### **Test Circuit 1**



### **Gate Trigger Current**

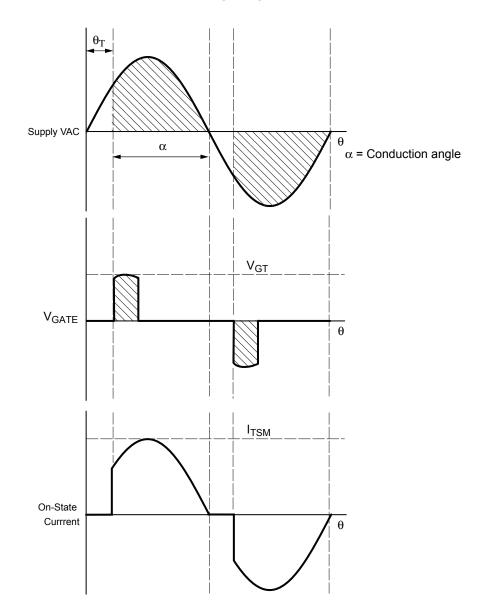




# SanKeñ



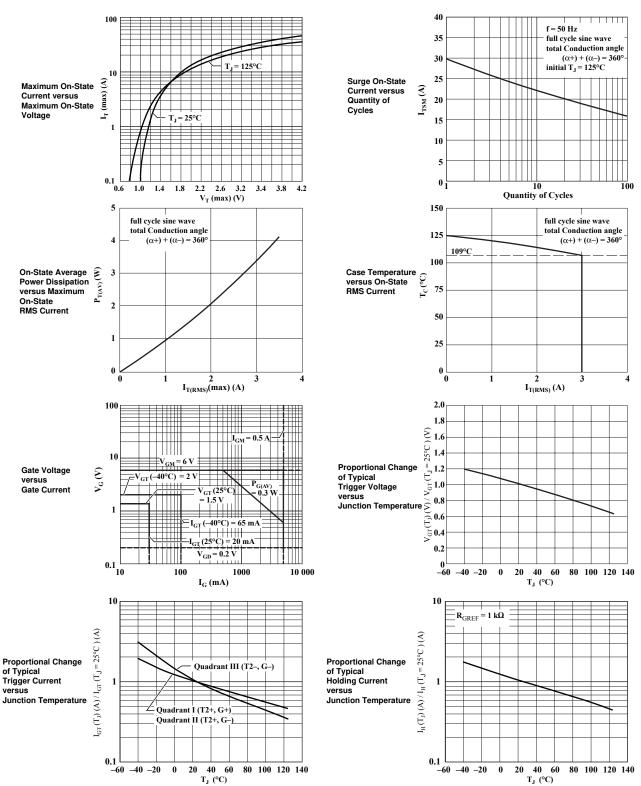
### **Commutation Timing Diagrams**







### Triac (Bidirectional Triode Thyristor)

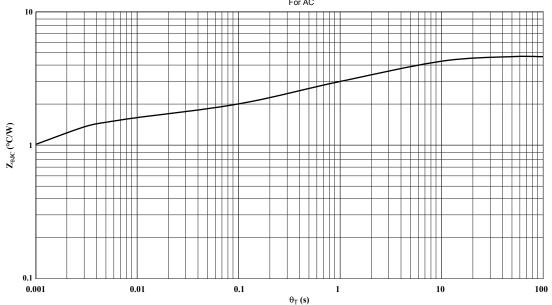


Performance Characteristics at T<sub>A</sub> = 25°C



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#### Transient Thermal Impedence versus Triac Voltage Pulse Duration For AC

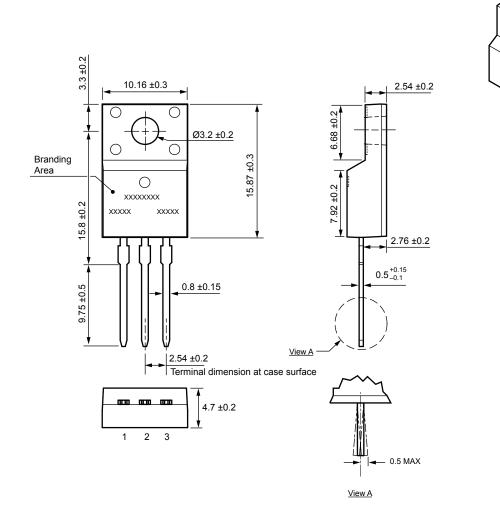




### Triac (Bidirectional Triode Thyristor)

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### **TO-220F Package Outline Drawing**



Terminal core material: Cu Terminal treatment: Sn plating Package: TO-220F

Dimensions in millimeters

Branding codes (exact appearance at manufacturer discretion): 1st line, type: TMA36H 2nd line left, lot: *YMDDR* Where: Y is the last digit of the year of manufacture M is the month (*1* to *9*, *O*, *N*, *D*) DD is the date R is a tracking letter



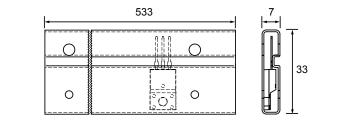
Leadframe plating Pb-free. Device meets RoHS requirements.

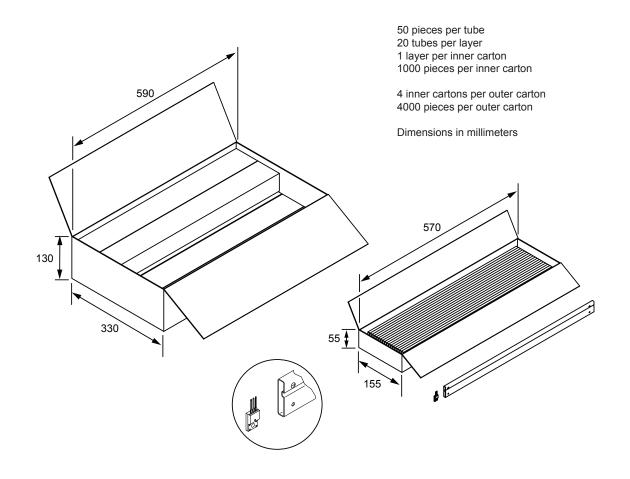


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Packing Specification Tube Packing









### Triac (Bidirectional Triode Thyristor)

WARNING — These devices are designed to be operated at lethal voltages and energy levels. Circuit designs that embody these components must conform with applicable safety requirements. Precautions must be taken to prevent accidental contact with power-line potentials. Do not connect grounded test equipment.

The use of an isolation transformer is recommended during circuit development and breadboarding.

Because reliability can be affected adversely by improper storage environments and handling methods, please observe the following cautions.

#### **Cautions for Storage**

- Ensure that storage conditions comply with the standard temperature (5°C to 35°C) and the standard relative humidity (approximately 40% to 75%); avoid storage locations that experience extreme changes in temperature or humidity.
- Avoid locations where dust or harmful gases are present and avoid direct sunlight.
- Reinspect for rust on leads and solderability of products that have been stored for a long time.

#### **Cautions for Testing and Handling**

When tests are carried out during inspection testing and other standard test periods, protect the products from power surges from the testing device, shorts between adjacent products, and shorts to the heatsink.

#### **Remarks About Using Silicone Grease with a Heatsink**

- When silicone grease is used in mounting this product on a heatsink, it shall be applied evenly and thinly. If more silicone grease than required is applied, it may produce stress.
- Coat the back surface of the product and both surfaces of the insulating plate to improve heat transfer between the product and the heatsink.
- Volatile-type silicone greases may permeate the product and produce cracks after long periods of time, resulting in reduced heat radiation effect, and possibly shortening the lifetime of the product.
- · Our recommended silicone greases for heat radiation purposes,

which will not cause any adverse effect on the product life, are indicated below:

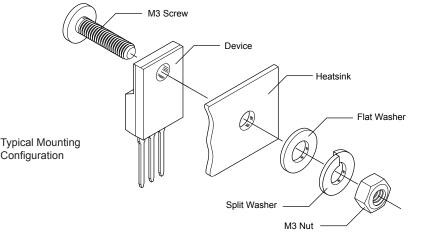
Туре		Suppliers
	G746	Shin-Etsu Chemical Co., Ltd.
	YG6260	Momentive Performance Materials
	SC102	Dow Corning Toray Silicone Co., Ltd.

#### **Heatsink Mounting Method**

- Torque When Tightening Mounting Screws. Thermal resistance increases when tightening torque is low, and radiation effects are decreased. When the torque is too high, the screw can strip, the heatsink can be deformed, and distortion can arise in the product frame. To avoid these problems, observe the recommended tightening torques for this product package type 0.490 to 0.686 N•m (5 to 7 kgf•cm).
- For effective heat transfer, the contact area between the product and the heatsink should be free from burrs and metal fragments, and the heatsink should be flat and large enough to contact over the entire side of the product, including mounting flange and exposed thermal pad.
- The mounting hole in customer-supplied heatsink must be less than Ø4 mm; this includes the diameter of any dimple around punched holes. This is to prevent possible deflection and cracking of the product case when fastened to the heatsink.

#### Soldering

- When soldering the products, please be sure to minimize the working time, within the following limits:
  - 260°C 10 s
  - 350°C 3 s
- Soldering iron should be at a distance of at least 1.5 mm from the body of the products





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### **Worldwide Contacts**

### Asia-Pacific

### China

### Sanken Electric Hong Kong Co., Ltd.

Suite 1026, Ocean Centre Canton Road, Tsimshatsui Kowloon, Hong Kong Tel: 852-2735-5262, Fax: 852-2735-5494

### Sanken Electric (Shanghai) Co., Ltd.

Room 3202, Maxdo Centre Xingyi Road 8, Changning District Shanghai, China Tel: 86-21-5208-1177, Fax: 86-21-5208-1757

#### Taiwan Sanken Electric Co., Ltd.

Room 1801, 18th Floor 88 Jung Shiau East Road, Sec. 2 Taipei 100, Taiwan R.O.C. Tel: 886-2-2356-8161, Fax: 886-2-2356-8261

#### Japan

### Sanken Electric Co., Ltd. Overseas Sales Headquarters

Metropolitan Plaza Building 1-11-1 Nishi-Ikebukuro, Toshima-ku Tokyo 171-0021, Japan Tel: 81-3-3986-6164, Fax: 81-3-3986-8637

### Korea

#### Sanken Electric Korea Co., Ltd.

Samsung Life Yeouido Building 16F 23-10, Yeouido-Dong, Yeongdeungpo-gu Seoul 150-734, Korea Tel: 82-2-714-3700, Fax: 82-2-3272-2145

### Singapore

### Sanken Electric Singapore Pte. Ltd.

150 Beach Road, #14-03 The Gateway West Singapore 189720 Tel: 65-6291-4755, Fax: 65-6297-1744

### <u>Europe</u>

Sanken Power Systems (UK) Limited Pencoed Technology Park Pencoed, Bridgend CF35 5HY, United Kingdom Tel: 44-1656-869-100, Fax: 44-1656-869-162

### North America

### **United States**

Allegro MicroSystems, Inc. 115 Northeast Cutoff Worcester, Massachusetts 01606, U.S.A. Tel: 1-508-853-5000, Fax: 1-508-853-7895

#### Allegro MicroSystems, Inc.

14 Hughes Street, Suite B105 Irvine, California 92618, U.S.A. Tel: 1-949-460-2003, Fax: 1-949-460-7837



